

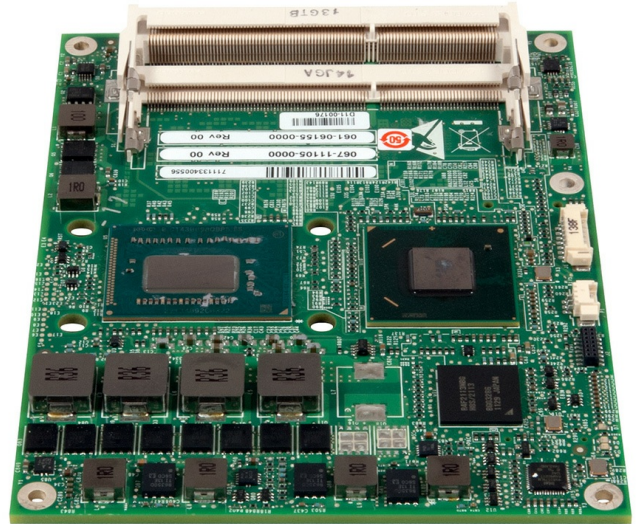
# CEQM77 ECC Type 6 95x125mm COM, 3rd Gen Intel Core i7

## Type 6, 95x125mm COM, 3rd Gen Intel Core i7, ECC

The CEQM77 ECC combines 3rd generation quad-core performance Intel Core i7 processor, error-correcting code (ECC) memory and the Mobile Intel QM77 Express chipset with Radisys design expertise to provide breakthrough processing performance on a basic size Type 6 COM Express Revision 2.0 module.

The basic size 95mm x 125mm module is ideal for compute intensive applications such as medical imaging, communications, military–aerospace and test and measurement applications that require ECC memory combined with high levels of processing performance.

Radisys delivers the CEQM77 ECC module in a COM Express Revision 2.0, Type 6 pin out, enabling customers to take advantage of new technology such as Digital Display Ports while boosting features and performance with up to 16GB memory, additional PCI Express lanes, and improved storage, graphics and audio.



The CEQM77 ECC module provides Trusted Platform Module (TPM) support as well as support for Intel Advanced Management Technology (AMT) enabling remote access and diagnostics via the Radisys Embedded Software Platform (eSP).

The Radisys CE family of COM Express products enable customers to start designing at the same time as processor release, saving months of development time and resources. OEM focus can remain on core competencies such as software and application development rather than high speed circuit design. Planned feature changes, demand fluctuations and performance upgrades can be handled without product re–designs using the CE family. CE modules can reduce service repair inventories, and simplify upgrades, contributing to the success of the product over its lifetime.

### PROCESSORS

Module Specs	Description	Compare Modules
<a href="#">CEQM77E-3612-0</a>	Intel Core i7 3612QE / 2.1GHz / 4 Core / 6MB Cache	<a href="#">Add to Comparison</a>
<a href="#">Compare All</a>		

### COM EXPERT DESIGN SERVICES

OEMs can depend on the Radisys COM Expert team to support their design at every stage, from schematic checks to the handling of entire custom carrier and system designs.

Radisys COM Expert services include options for software utilities, custom BIOS, mechanical models, debug assistance and more to customers using Radisys CE processor modules. Design consulting and debug services are also available to support OEM product development at any stage; ask your Radisys Account Executive for more information.

### FEATURES

- Intel Core i7 and i5 Processor options
  - Intel Core i7 3612QE, 2.1GHz
- Mobile Intel QM77 Express chipset
- Dual-channel DDR3 ECC memory, up to 16GB
- Type 6 COM Express Revision 2.0
- Basic 95mm x 125mm size
- Seven PCI Express x1 ports
- One PCI Express x16 PEG port (Gen3)
- Three Digital Display Interfaces (DDI)
- Single Gigabit Ethernet
- 8 USB ports, including 4 USB 3.0 ports
- TPM and AMT support

## SPECIFICATIONS

Feature	Function	Description
<b>Pin-Out</b>	Type	Type 6, 95mm x 125mm
	Compliance	PICMG COM Express R2.0 Basic Form Factor
<b>Processor</b>	3612QE	Core™ i7 3612QE 2.1GHz / 4 Core / 6MB cache / 35W
	<b>Chipset</b>	Mobile Intel® QM77 Express chipset
	<b>Memory</b>	Type Capacity
<b>Flash</b>	16MB system flash for BIOS storage	
<b>Video</b>	Intel® Gen 7th integrated graphics engine	LVDS supports 18 bit or 24 bit single/dual channel panel with resolutions up to 1920×1200 pixels at 60 Hz VGA with resolutions up to 1920×1200 pixels at 60Hz Up to 3 Digital Display Interfaces · DDI 1 (PCH Port B) supports DisplayPort, HDMI or SDVO · DDI 2 (PCH Port C) supports DisplayPort or HDMI · DDI 3 (PCH Port D) supports DisplayPort, HDMI or eDP · The resolutions of DisplayPort can support upto 2560×1600 pixels at 60Hz
	External	One x16 PCI Express interface for external PCIe x16 graphics device,
	<b>Networking</b>	Single LAN
<b>Audio</b>	High Definition Audio	
	Speaker Out	
<b>Ethernet</b>	One 10/100/1000BaseT Giga LAN	

<b>Storage</b>	SATA	4 SATA ports supporting both 1.5 and 3.0 Gbps operation Supports RAID 0, 1, 5 and 10 The first two ports supporting 6Gb/s transfer rate
<b>PCI Express</b>	PCI Express x1	Seven PCI Express x1 Ports: <ul style="list-style-type: none"> <li>Ports 0–3 configurable as one x4, or two x2; or one x2 and two x1; or four x1 ports.</li> <li>Ports 4-6 can be configured as three x1 or one x2 and one x1 ports</li> </ul>
	PCI Express x16	One PCI Express x16 Graphics Expansion Port – Configurable as two x8 or one x8 and two x4 ports
<b>USB</b>		Four USB3.0 expansion ports with transfer rate up to 5Gb/s Eight USB 2.0 expansion ports (first four ports combine with USB3.0 ports)
<b>LPC</b>		One LPC interface
<b>TPM</b>		ATMEL AT97SC3204 compliant with TPM1.2
<b>Power</b>		+12 power rail, primary input Supports 9.0V–16.8V power supply
<b>Power Management</b>		ACPI 4.0 supporting states 50, 53, 54, 55 63 and C0, C1, C3, C6, C7 AMT support Intel ME Power States M0, M3, Mox
<b>Miscellaneous</b>		One 100KHz SMBus from PCH
		One 100KHz I2C bus from MCU
		Eight GPIO (four GPI and four GPO)
		Watchdog timer
<b>BIOS</b>		AMI Aptio EFI Firmware
<b>OS</b>	Windows XP®	Embedded Professional 32bit Professional 64bit
	Windows 7	32bit 64bit
	Red Hat Enterprise Linux	32bit 64bit
	Fedora Linux	32bit and 64bit

## Physical Specifications

Physical	Dimensions	95mm x 125mm
	Compliance	PICMG COM Express R2.0 Basic Form Factor, Type 6

Environment	Cooling	Forced air	Class EAC1 as defined in the ANSI/VITA 47-2005
		Conduction	Class ECC1 as defined in the ANSI/VITA 47-2005
Temperature	Operating	Up to 2300m (7500 ft), 0 to 60C Derated -1.1 C per 305 m (1000 ft) above 2300 m (7500 ft)	
	Non-operating	-40°C to +85°C	
Shock	Operating	30G, half sine shock pulse, 11ms duration, 3 times per face	
	Non-Operating/Unpacked	40G, half sine shock pulse, 11ms duration, 3 times per face (unpackaged)	
	Transportation/Packaged	Fixtured assembly: 50G, 17.4 ms trapezoidal pulse  Drop test, 10-up bulk packaging, 30in free-fall, one drop on each of six faces	
Vibration (random)	Operating	Random 5Hz to 2KHz, 7.7 grms, 10min in each of 3 axes 5Hz – 20Hz: 0.004g <sup>2</sup> /Hz ramping up to 0.04g <sup>2</sup> /Hz  20Hz to 1000Hz: 0.04g <sup>2</sup> /Hz  1000Hz to 2000Hz: 0.04g <sup>2</sup> /Hz ramping down to 0.01g <sup>2</sup> /Hz	
	Non-Operating/Storage	Random 5Hz to 2KHz, 9.7 grms, 10min in each of 3 axes 5Hz – 20Hz: 0.006g <sup>2</sup> /Hz ramping up to 0.06g <sup>2</sup> /Hz  20Hz to 1000Hz: 0.06g <sup>2</sup> /Hz  1000Hz to 2000Hz: 0.06g <sup>2</sup> /Hz ramping down to 0.02g <sup>2</sup> /Hz	
Humidity	Operating	5% to 95% non-condensing. 95%RH@30C, linear derating to 25%RH@60C	
	Non-Operating/Storage	5% to 95% non-condensing	
Altitude	Operating	To 15,000ft (4570m)	
	Non-Operating/Storage	To 40,000ft (12000m)	
Regulatory	Safety	UL60950-1, EN60950-1, IEC60950-1	
		RoHS compliant	
	EMC	EN55024, EN55022, and FCC Part 15, Subpart B, Class B	

## MORE DETAILS

### Order Codes:

- CEQM77E-3612-0: Core i7-3612QE, 2.1GHz, 2 Core, 6M Cache, HDG3000, TPM, ECC

### Supporting Products:

- CE-4GB-DDR3E: 4GB DDR3 SODIMM ECC Memory, 0C to 60C
- CE-8GB-DDR3E: 8GB DDR3 SODIMM ECC Memory, 0C to 60C
- CEQM67-AHS: Active Heat Sink
- CEQM67-77-HSP: Heatspreader
- CEQM67-77-PHSA: Passive Heat Sink
- CR300-1: Type 6 COM Express Development Carrier

## SUPPORT DOWNLOADS

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